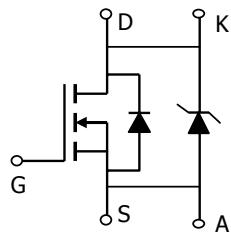
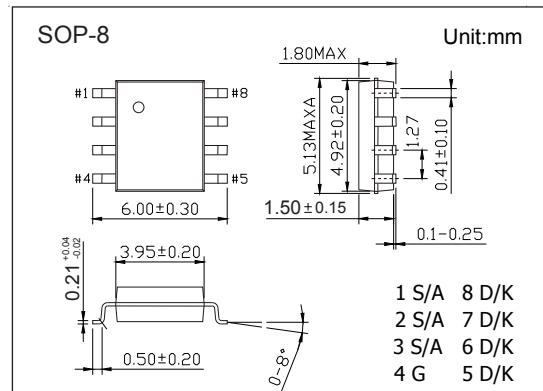


N-Channel MOSFET

AO4702 (KO4702)

■ Features

- $V_{DS(V)} = 30V$
- $I_D = 11 A$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 16m\Omega$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 25m\Omega$ ($V_{GS} = 4.5V$)
- $V_{DS(V)} = 30V$, $I_F = 3A$, $V_F < 0.5V @ 1A$



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	MOSFET	Schottky	Unit
Drain-Source Voltage	V_{DS}	30		V
Gate-Source Voltage	V_{GS}	± 20		
Schottky Reverse Voltage	V_{KA}		30	
Continuous Drain Current	I_D	11		A
		9.3		
Pulsed Drain Current	I_{DM}	50		A
Continuous Forward Current	I_F		4.4	
			3.2	
Pulsed Diode Forward Current	I_{FM}		30	W
Power Dissipation	P_D	3	3	
		2	2	
Thermal Resistance.Junction- to-Ambient	R_{thJA}	40	40	$^\circ C/W$
		75	75	
Thermal Resistance.Junction- to-Lead	R_{thJL}	24	30	$^\circ C$
Junction Temperature	T_J	150		
Storage Temperature Range	T_{stg}	-55 to 150		

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■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250 μA, V _{GS} =0V	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			0.05	mA
		V _{DS} =30V, V _{GS} =0V, T _J =125°C			10	
		V _{DS} =30V, V _{GS} =0V, T _J =150°C			20	
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250 μA	1	3		V
Static Drain-Source On-Resistance	R _{D(on)}	V _{GS} =10V, I _D =11A			16	mΩ
		V _{GS} =10V, I _D =11A, T _J =125°C			21	
		V _{GS} =4.5V, I _D =8A			25	
On State Drain Current	I _{D(ON)}	V _{GS} =4.5V, V _{DS} =5V	40			A
Forward Transconductance	g _F	V _{DS} =5V, I _D =11A		25		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =15V, f=1MHz		1040	1250	pF
Output Capacitance	C _{oss}			212		
Reverse Transfer Capacitance	C _{rss}			121		
Gate Resistance	R _G	V _{GS} =0V, V _{DS} =0V, f=1MHz		0.7	0.85	Ω
Total Gate Charge (10V)	Q _g	V _{GS} =10V, V _{DS} =15V, I _D =11A		19.8	24	nC
Total Gate Charge (4.5V)				9.8	12	
Gate Source Charge	Q _{gs}			2.5		
Gate Drain Charge	Q _{gd}			3.5		
Turn-On DelayTime	t _{d(on)}	V _{GS} =10V, V _{DS} =15V, R _L =1.35Ω, R _{GEN} =3Ω		4.5	7	ns
Turn-On Rise Time	t _r			3.9	7	
Turn-Off DelayTime	t _{d(off)}			17.4	30	
Turn-Off Fall Time	t _f			3.2	5.7	
Body Diode Reverse Recovery Time	t _{rr}	I _F = 11A, dI/dt= 100A/us		19	23	nC
Body Diode Reverse Recovery Charge	Q _{rr}			9	11	
Body-Diode + Schottky Continuous Current	I _s				5	A
Diode + Schottky Forward Voltage	V _{SD}	I _s =1A, V _{GS} =0V			0.5	V

Note. The static characteristics in Figures 1 to 6 are obtained using 300 μs pulses, duty cycle 0.5% max

■ Marking

Marking	4702
	KC****

N-Channel MOSFET

AO4702 (KO4702)

■ Typical Characteristics

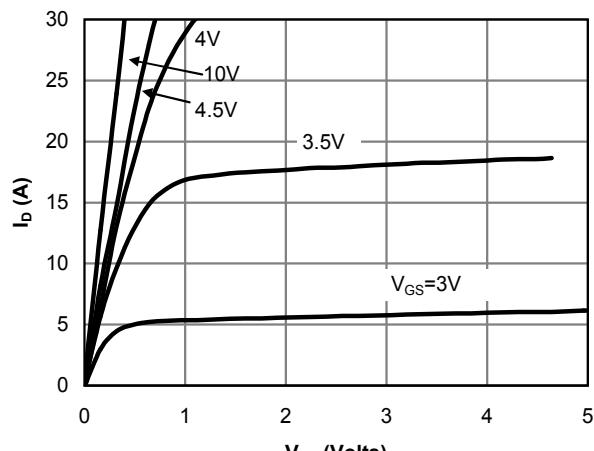


Fig 1: On-Region Characteristics

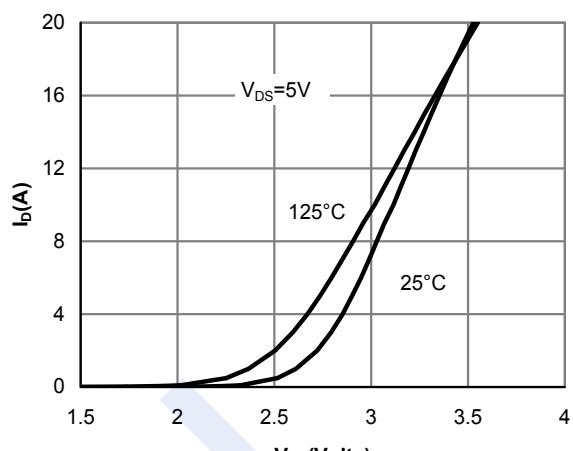


Figure 2: Transfer Characteristics

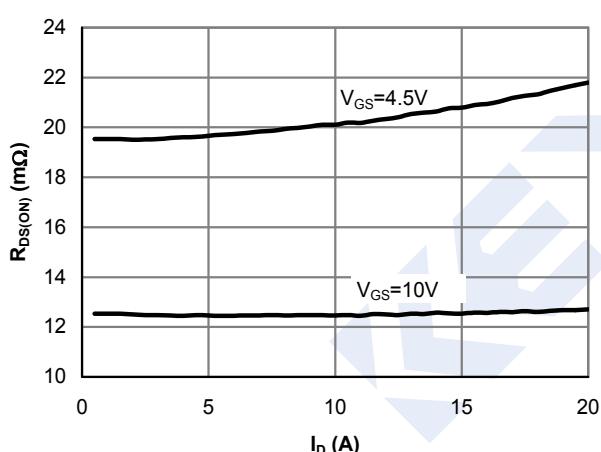


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

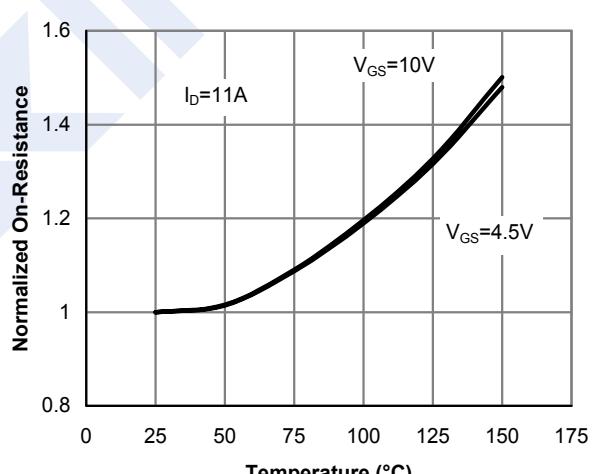


Figure 4: On-Resistance vs. Junction Temperature

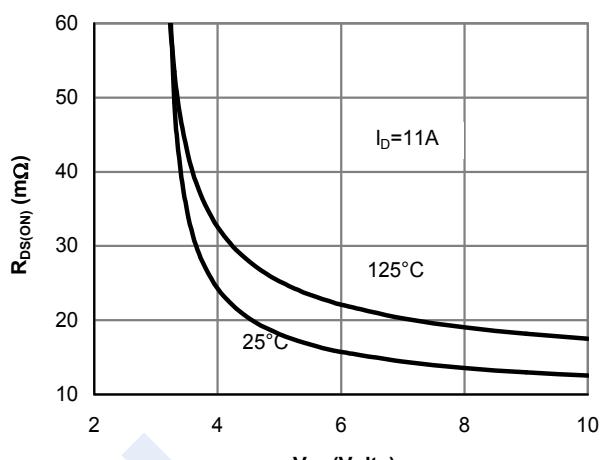


Figure 5: On-Resistance vs. Gate-Source Voltage

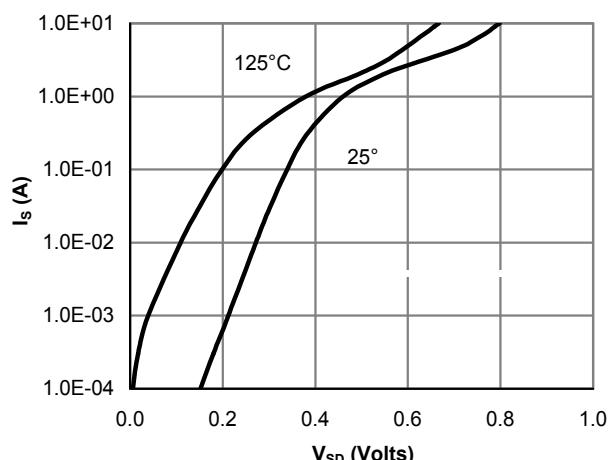


Figure 6: Body-Diode Characteristics

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■ Typical Characteristics

